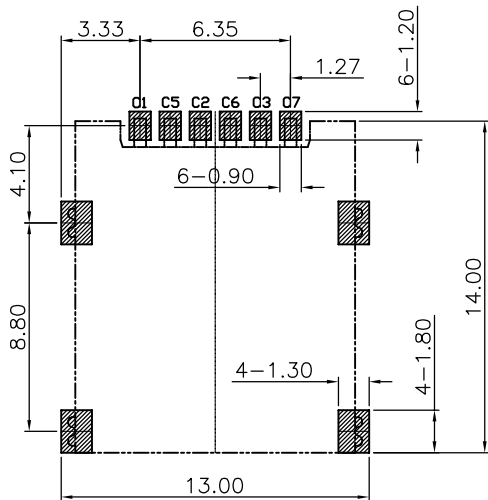
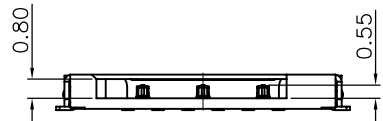
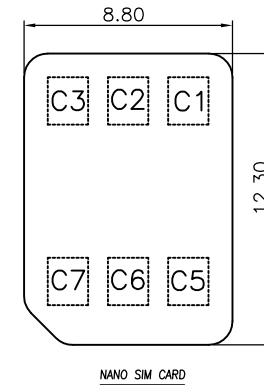
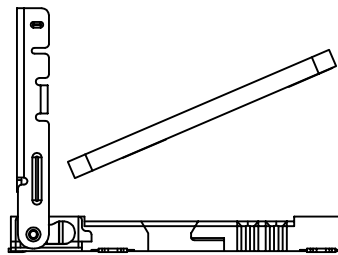
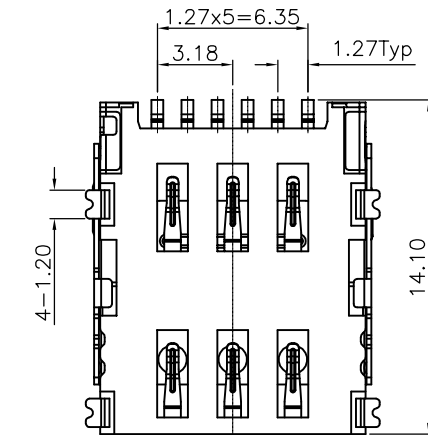


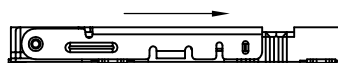
SIM CARD	
Pin No.	NAME
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O



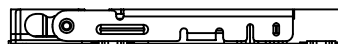
RECOMMENDED PCB LAYOUT
GENERAL TOLERANCE ±0.05



STEP 1 INSERT Micro-SIM CARD



STEP 2 PUSH THE SHELL



STEP 3 FINISH

NOTES:

- ELECTRICAL CHARACTERISTICS
 - 1-1. CONTACT RESISTANCE: 60 Milliohms Max
 - 1-2. INSULATION RESISTANCE: 1,000 Megohms Min.
 - 1-3. VOLTAGE RATING: 50V.
 - 1-4. CURRENT RATING: 1.0A.
- MECHANICAL CHARACTERISTICS
 - 2-1. OPERATION TEMPERATURE RANGE: -20°C~+85°C
 - 2-2. DURABILITY: 5000 CYCLES
- MATERIAL:
 - 3-1. HOUSING: THERMOPLASTIC,UL 94-V0
 - 3-2. TERMINAL: PHOSPHOR BRONZE,T=0.15
 - 3-3. SHELL: STAINLESS STEEL,T=0.20
- FINISHED:
 - 4-1. TERMINAL: Ni PLATED UNDER, 3U" Au MIN PLATED ON CONTACT AREA,AU PLATED ON SOLDER TAIL



深圳市华宇创精密电子有限公司

TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X: ±2° X.X° ±0.5°	DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME: NANO SIM 6P 掀盖1.5H
	CHECKED BY: 马跃	DATE : 2014-02-23	PART NO. : HYCW300-SIM06-150B
UNIT: mm [inch] SCALE:1:1 SIZE: A4	APPROVED BY: 邱敏	DATE : 2014-02-23	PART NO. : HYC-2111161448
			MOLD NO. : DRAW NO. : SHEET NO. : 1 OF 1